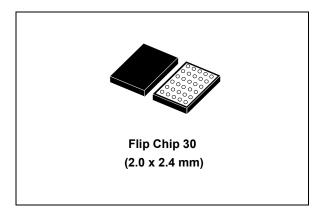


Low voltage high bandwidth quad DPDT switch

Datasheet - production data



Features

- Ultralow power dissipation
 - $I_{CC} = 1 \mu A \text{ (max.)} \text{ at } T_A = 85 \text{ °C}$
- Low "ON" resistance
 - R_{ON} = 5.4 Ω (T_A = 25 °C) at V_{CC} = 4.3 V
 - R_{ON} = 6.6 Ω (T_A = 25 °C) at V_{CC} = 3.0 V
- · Wide operating voltage range
 - V_{CC} (OPR.) = 1.65 V to 4.3 V
- 4.3 V tolerant and 1.8 V compatible threshold on digital control input at V_{CC} = 2.3 V to 3.0 V
- · 4 select pins controlling 2 switches each
- Typical bandwidth (-3 dB) at 800 MHz on all channels
- USB (2.0) high speed (480 Mbps) signal switching compliant
- · Integrated fail safe function
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD performance exceeds JESD22 2000-V human body model (A114-A)

Applications

Mobile phones

Description

The STG3820 device is a high-speed CMOS low voltage quad analog DPDT (dual pole dual throw) switch or 2:1 multiplexer/demultiplexer switch fabricated in silicon gate C²MOS technology. It is designed to operate from 1.65 V to 4.3 V, making this device ideal for portable applications.

The SELm-n input is provided to control the switches. The switches nS1 and mS1 are ON (connected to common ports Dn and Dm respectively) when the SELm-n input is held high and OFF (high impedance state exists between the two ports) when the SELm-n is held low. The switches nS2 and mS2 are ON (connected to common port Dn and Dm respectively) when the SELm-n input is held low and OFF (high impedance state exists between the two ports) when the SELm-n is held high.

The STG3820 device has an integrated fail safe function to withstand overvoltage condition when the device is powered off. Additional key features are fast switching speed, break-before-makedelay time and ultralow power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Table 1. Device summary

Order code	Package	Packing
STG3820BJR	Flip Chip 30 (2.0 x 2.4 mm)	Tape and reel

Contents STG3820

Contents

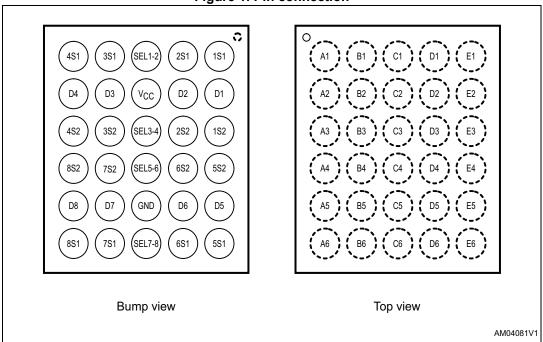
1	Pin settings	. 3
	1.1 Pin connection	. 3
	1.2 Pin description	. 3
2	Logic diagram	. 5
3	Maximum ratings	. 6
	Recommended operating conditions	. 6
4	Electrical characteristics	. 7
5	Test circuits	12
6	Package information	16
7	Pavision history	19

STG3820 Pin settings

1 Pin settings

1.1 Pin connection

Figure 1. Pin connection



1.2 Pin description

Table 2. Pin assignment

Pin number	Symbol	Name and function
A1	1S1	Independent channel for switch 1
A2	D1	Common channel for switch 1
A3	1S2	Independent channel for switch 1
A4	5S2	Independent channel for switch 5
A5	D5	Common channel for switch 5
A6	5S1	Independent channel for switch 5
B1	2S1	Independent channel for switch 2
B2	D2	Common channel for switch 2
B3	2S2	Independent channel for switch 2
B4	6S2	Independent channel for switch 6
B5	D6	Common channel for switch 6
B6	6S1	Independent channel for switch 6

Pin settings STG3820

Table 2. Pin assignment (continued)

Pin number	Symbol	Name and function
C1	SEL1-2	Switch 1-2 selection control
C2	VCC	Positive supply voltage
C3	SEL3-4	Switch 3-4 selection control
C4	SEL5-6	Switch 5-6 selection control
C5	GND	Ground (0 V)
C6	SEL7-8	Switch 7-8 selection control
D1	3S1	Independent channel for switch 3
D2	D3	Common channel for switch 3
D3	3S2	Independent channel for switch 3
D4	7S2	Independent channel for switch 7
D5	D7	Common channel for switch 7
D6	7S1	Independent channel for switch 7
E1	4S1	Independent channel for switch 4
E2	D4	Common channel for switch 4
E3	4S2	Independent channel for switch 4
E4	8S2	Independent channel for switch 8
E5	D8	Common channel for switch 8
E6	8S1	Independent channel for switch 8

STG3820 Logic diagram

2 Logic diagram

Dn nS2

Figure 2. Logic equivalent circuit

Table 3. Truth table

SEL	Switch nS1	Switch nS2
Н	ON	OFF ⁽¹⁾
L	OFF ⁽¹⁾	ON

^{1.} High impedance.

AM00789V1

Maximum ratings STG3820

3 Maximum ratings

Stressing the device above the rating listed in *Table 4: Absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in *Table 5: Recommended operating conditions* of this specification is not implied. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to 6.0	V
V _I	DC input voltage	-0.5 to V _{CC} + 0.5	V
V _{IC}	DC control input voltage	-0.5 to 5.5	V
V _O	DC output voltage	-0.5 to V _{CC} + 0.5	V
I _{IKC}	DC input diode current on control pin (V _{SEL} < 0 V)	-50	mA
I _{IK}	DC input diode current (V _{SEL} < 0 V)	±50	mA
I _{OK}	DC output diode current	±20	mA
I _O	DC output current	±128	mA
I _{OP}	DC output current peak (pulse at 1 ms, 10% duty cycle)	±300	mA
I _{CC} or I _{GND}	DC V _{CC} or ground current	±100	mA
P _D	Power dissipation at T _A = 70 °C	1120	mW
T _{stg}	Storage temperature	-65 to +150	°C
T _L	Lead temperature (10 sec.)	300	°C

Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Paramet	Value	Unit	
V_{CC}	Supply voltage	1.65 to 4.3	V	
VI	Input voltage	0 to V _{CC}	V	
V _{IC}	Control input voltage	0 to 4.3	V	
V _O	Output voltage		0 to V _{CC}	V
T _{op}	Operating temperature		-40 to 85	°C
dt/dv	Input rise and fall time control	V _L = 1.65 V to 2.7 V	0 to 20	no/\/
ui/uv	input	0 to 10	ns/V	

6/20 DocID15992 Rev 4

4 Electrical characteristics

Table 6. DC specifications

						Value				
Symbol	Parameter	V _{CC} (V)	Test conditions		T _A = 25 °C			-40 to 85 °C		
				Min.	Тур.	Max.	Min.	Max.		
		1.65 – 1.95		0.65 V _{CC}	_	_	0.65 V _{CC}	-		
	High level input	2.3 – 2.5		1.2	_	_	1.2	_		
V _{IH}	voltage	2.7 – 3.0		1.3	_	_	1.3	_	V	
		3.3 – 3.6		1.4	_	_	1.4	_		
		4.3		1.6	_	_	1.6	_		
		1.65 – 1.95		_	_	0.25	_	0.25		
		2.3 – 2.5		-	_	0.25	_	0.25		
	Low level input voltage	2.7 – 3.0		-	_	0.25	_	0.25	V	
		3.3 – 3.6		-	_	0.30	_	0.30		
		4.3		_	_	0.40	_	0.40		
		1.8	$V_S = 0 \text{ V to } V_{CC}$ $I_S = 8 \text{ mA}$	1	17.0	19.6	_	_	Ω	
		2.7		-	7.5	8.7	_	_		
R _{PEAK}	Switch ON peak resistance	3.0		-	6.6	7.6	_	_		
		3.7	3 -	_	5.8	6.7	_	_		
		4.3		1	5.4	6.2	_	_		
D	Switch ON	3.0	$V_S = 3 V$ $I_S = 8 \text{ mA}$	_	5.1	5.8	_	-	0	
R _{ON}	resistance	3.0	$V_S = 0.4 \text{ V}$ $I_S = 8 \text{ mA}$	_	6.3	7.3	_	_	Ω	
		1.8		_	_	_	_	_		
	ON resistance	2.7		_	_	_	_	_	Ω	
ΔR_{ON}	match between	3.0	V_S at R_{ON} MAX $I_S = 8$ mA	_	0.3	_	_	_		
	channels ⁽¹⁾	3.7	.5 0 (_	_	_	_	_		
		4.3		_	_	_	_	_		

Electrical characteristics STG3820

Table 6. DC specifications (continued)

						Value			Unit
Symbol	Parameter	V _{CC} (V)	Test conditions	7	Γ _A = 25 °C		-40 to	85 °C	
				Min.	Тур.	Max.	Min.	Max.	
		1.8	$V_S = 0 \text{ V to}$ 0.4 V $I_S = 8 \text{ mA}$	_	4.5	_	_	_	
		1.8		_	9.5	_	_	_	
R _{FLAT}	ON resistance flatness ⁽²⁾	2.7		_	2.2	_	_	_	Ω
		3.0	$V_S = 0 \text{ V to } V_{CC}$ $I_S = 8 \text{ mA}$	_	1.8	_	_	_	
		3.7		_	1.6	_	_	_	
		4.3		_	1.6	_	_	_	
l _{OFF}	OFF state leakage current (Sn), (D)	4.3	V _S = 0.3 or 4 V	-20	_	20	-100	100	nA
I _{IN}	Input leakage current	0 to 4.3	V _{SEL} = 0 to 4.3 V	-0.2	_	0.2	-1.0	1.0	μA
I _{CC}	Quiescent supply current	1.65 to 4.3	V _{SEL} = V _{CC} or GND	-0.2	_	0.2	-1.0	1.0	μA
	Quiescent supply		V _{SEL} = 1.65 V	_	±37	±50	_	±100	
I _{CCLV}	current for low	4.3	V _{SEL} = 1.80 V	_	±33	±40	_	±50	μA
	voltage driving ⁽³⁾		V _{SEL} = 2.60 V	_	±11	±20	_	±30	

^{1.} ΔR_{ON} = max. |mSN - nSN|, where m = 1 to 8 and n = 1 to 8, N = 1, 2.

^{2.} Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

^{3.} Measurement is for one SEL pin.

Table 7. AC electrical characteristics (C $_L$ = 35 pF, R $_L$ = 50 $\Omega,\,t_r$ = $t_f~\leq~5$ ns)

						Value			
Symbol	Parameter	V _{CC} (V)	Test conditions		T _A = 25 °C			85 °C	Unit
				Min.	Тур.	Max.	Min.	Max.	
		1.65 - 1.95		_	0.21	_	_	-	
t t	Propagation	2.3 - 2.7		_	0.15	_	_	-	ns
t _{PLH} , t _{PHL}	delay	3.0 - 3.3		_	0.14	_	_	_	113
		3.6 - 4.3		_	0.13	_	_	-	
		1.65 - 1.95	$V_{S} = 0.8 V$	_	36	_	_	-	
t _{ON} Turn-on time	2.3 - 2.7		_	20	23	_	26	ns	
	3.0 - 3.3	$V_{S} = 1.5 V$	_	15	17	_	20	113	
		3.6 - 4.3		_	13	15	_	17	
		1.65 - 1.95	$V_{S} = 0.8 V$	_	29	_	_	-	
t	Turn-off time	2.3 - 2.7		_	19	22	_	25	ns
t _{OFF}	rum-on ume	3.0 - 3.3	$V_{S} = 1.5 V$	_	14	16	_	18	113
		3.6 - 4.3		_	11	13	_	14	
		1.65 - 1.95		_	10	_	_	-	
t_	Break-before-	2.3 - 2.7	$C_L = 35 \text{ pF}$ $R_L = 50 \Omega$	_	7	_	_	-	Ī
t _D	make time delay	3.0 - 3.3	$V_{S} = 1.5 \text{ V}$	_	6	_	_	-	ns
		3.6 - 4.3		_	4	_	_	-	
		1.65		_	3.9	_	_	_	
Q	Charge injection	2.3	$C_L = 100 \text{ pF}$	_	4.8	_	_	-	- pC
	Onarge injection	3.0	$V_{GEN} = 0 V$ $R_{GEN} = 0 \Omega$	_	5.2	_	_	_	
		4.3		_	6.4	_	_	_	

Electrical characteristics STG3820

Table 8. AC electrical characteristics (C $_L$ = 5 pF, R $_L$ = 50 $\Omega,$ T $_A$ = 25 $^{\circ}C)$

						Value			
Symbol	Parameter	V _{CC} (V)	Test conditions	T _A = 25 °C			-40 to	85 °C	Unit
				Min.	Тур.	Max.	Min.	Max.	
OIRR OFF isolation ⁽¹	OFF := clation(1)	4.05 4.0	$V_S = 1 V_{RMS}$, f = 1 MHz signal = 0 dBm	_	-78	_	_	-	٩D
	OFF Isolation(*)	1.65 – 4.3	$V_S = 1 V_{RMS}$, f = 10 MHz signal = 0 dBm	_	-57	_	_	_	dB
	Crosstalk	1.65 – 4.3	$V_S = 1 V_{RMS}$, f = 1 MHz signal = 0 dBm	_	-78	_	_	_	dB
Xtalk	Ciossidik	1.00 4.0	$V_S = 1 V_{RMS}$, f = 10 MHz signal = 0 dBm	_	-58	_	_	I	uБ
BW	-3dB bandwidth	3.0 – 4.3	$R_L = 50 \Omega$ signal = 0 dBm	_	800	_	_	-	MHz
C _{IN}	Control pin input capacitance		V _{CC} = 0 V	_	2	_	_		pF
C	Sn port capacitance	port capacitance 3.3	F = 240 MHz, switch is enabled	_	6	_	_	_	pF
C _{Sn}	on port capacitance		F = 240 MHz, switch is disabled	_	2	_	_	_	рг
C _D	D port capacitance	3.3	F = 240 MHz	_	8	_	_		pF

^{1.} Off isolation = 20 Log10 (V_D/V_S), V_D = output, V_S = input to off switch.

Table 9. USB related AC electrical characteristics

Symbol									
	Parameter	V _{CC} (V)	Test conditions	T _A = 25 °C			-40 to 85 °C		Unit
				Min.	Тур.	Max.	Min.	Max.	
t _{SK(0)}	Channel-to- channel skew	3.0 - 3.6	C _L = 10 pF	_	26	_	_	_	ps
t _{SK(P)}	Skew of opposite transition of the same output	3.0 - 3.6	C _L = 10 pF	_	60	_	_	_	ps
TJ	Total jitter	3.0 - 3.6	$R_L = 50 \Omega$ $C_L = 10 \text{ pF}$ $t_R = t_F = 750 \text{ ps}$ at 480 Mbps	l	130	-	-	_	ps

Test circuits STG3820

5 Test circuits

Figure 3. On-resistance

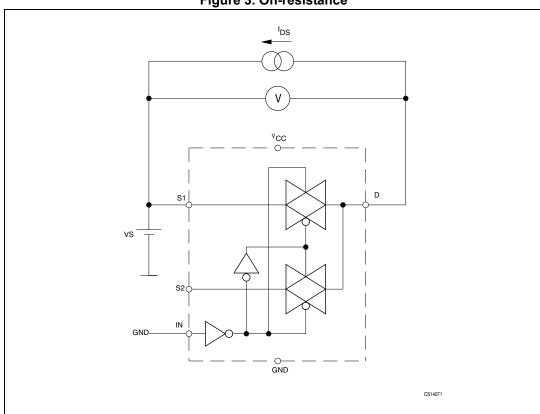
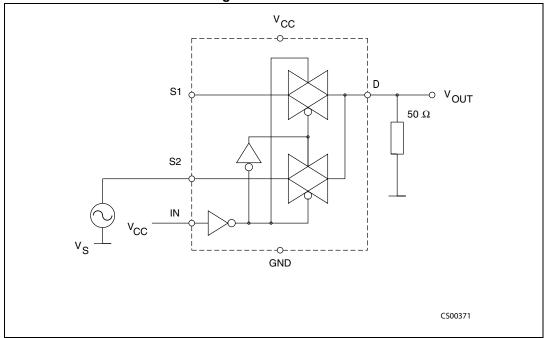


Figure 4. Bandwidth



STG3820 Test circuits

Figure 5. Off leakage

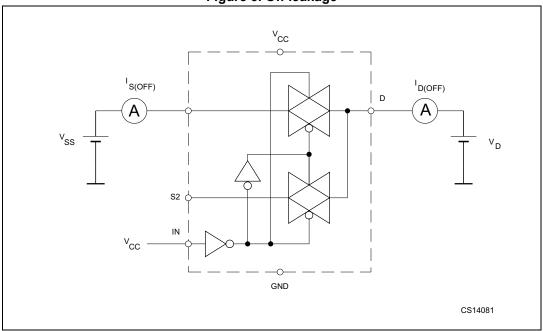
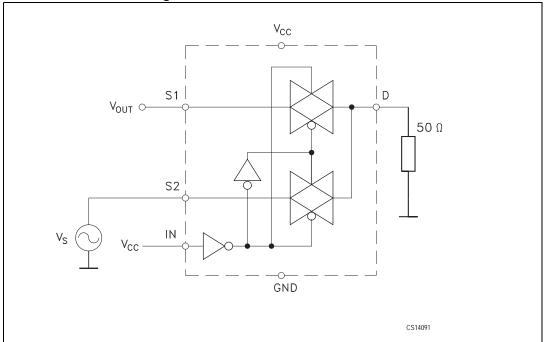


Figure 6. Channel to channel crosstalk



Test circuits STG3820

Figure 7. Off isolation

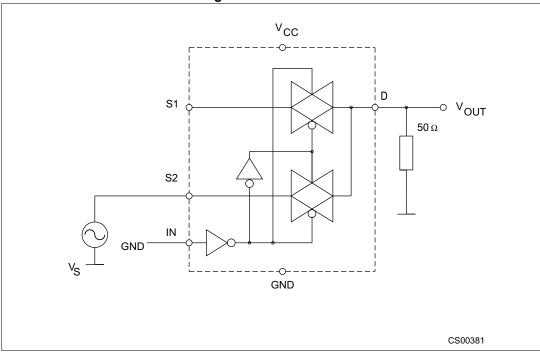
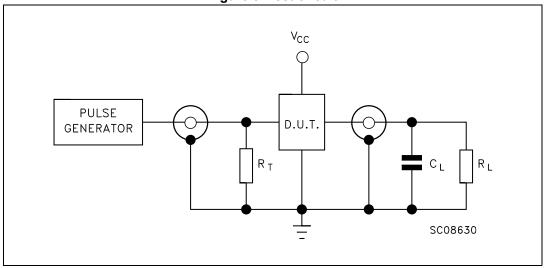


Figure 8. Test circuit



Note:

 $C_L = 5/35 pF$ or equivalent: (includes jig capacitance).

 R_L = 50 Ω or equivalent.

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω).

57/

STG3820 Test circuits

Figure 9. Break-before-make time delay

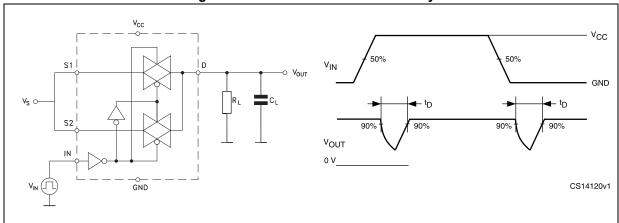


Figure 10. Switching time and charge injection (V_{GEN} = 0 V, R_{GEN} = 0 Ω , R_L = 1 M Ω , C_L = 100 pF)

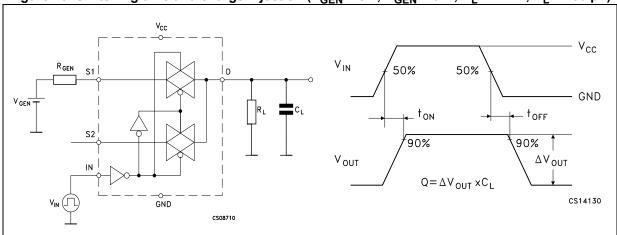
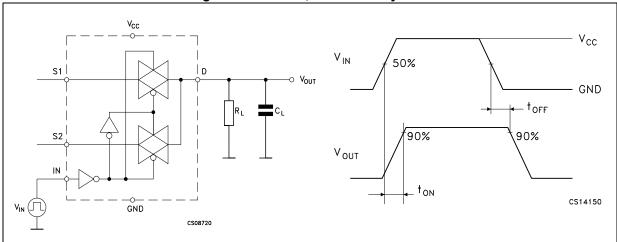


Figure 11. Turn-on, turn-off delay time



Package information STG3820

6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 12. Package outline for Flip Chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch D1 Øb **BOTTOM VIEW** Ε D **TOP VIEW**

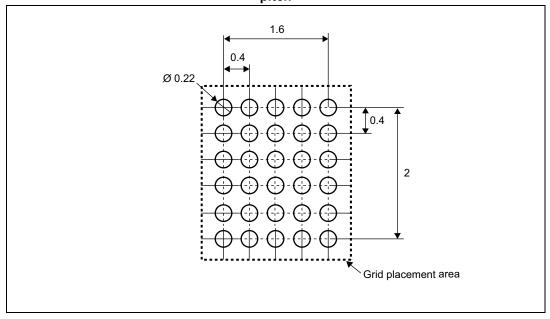
Flip Chip 30

STG3820 Package information

Table 10. Mechanical data for Flip Chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch

Symbol	Dimensions (mm)		
	Min.	Тур.	Max.
Α	0.565	0.625	0.685
A1	0.17	0.205	0.24
A2	0.355	0.375	0.395
b	0.215	0.255	0.295
D	2.1	2.4	2.43
D1	_	2.0	-
E	1.97	2.0	2.03
E1	_	1.6	-
е	0.36	0.4	0.44
f	0.19	0.2	0.21
ccc	_	0.05	_
\$	0.040	0.045	0.05

Figure 13. Footprint recommendations for Flip Chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch

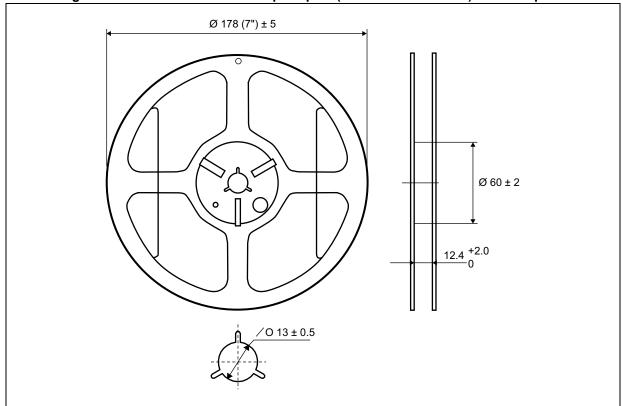


Package information STG3820

 2.00 ± 0.05 4.00 ± 0.10 4.00 ± 0.10 Ø 1.50 ± 0.10 1.75 ± 0.10 + 3.50 ± 0.05 8.00 ^{+0.30} _{-0.10} 0.20 ± 0.02 45° 45° 2.18 ± 0.05 0.73 ± 0.05 2.54 ± 0.05 Αo Во Ko

Figure 14. Tape information for Flip Chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch





STG3820 Revision history

7 Revision history

Table 11. Document revision history

Date	Revision	Changes	
18-Dec-2009	1	Initial release.	
19-Jan-2011	2	Document reformatted, added <i>Contents</i> , updated <i>Figure 12</i> and <i>Figure 13</i> , corrected typo in <i>Features</i> , <i>Table 1</i> , <i>Section 1: Pin settings</i> , <i>Table 2</i> , <i>Table 7</i> , <i>Table 8</i> , notes below <i>Figure 8</i> , title of <i>Figure 11</i> , <i>Figure 12</i> , <i>Table 10</i> , and <i>Figure 13</i> , corrected name of "Table 11" to <i>Figure 13</i> .	
23-Apr-2013	3	Moved <i>Description</i> to page 1. Redrawn <i>Figure 1</i> . Updated <i>Section 3</i> (added/updated cross-references, updated V _{CC} value in <i>Table 4</i>). Redrawn <i>Figure 12</i> to <i>Figure 15</i> . Updated <i>Figure 12</i> (removed superfluous reference to note). Updated title of <i>Figure 14</i> and <i>Figure 15</i> (added "Flip Chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch"). Minor corrections throughout document.	
06-Aug-2013	4	Updated Table 8 on page 10 (replaced C_{ON} and C_{OFF} symbol by C_{sn} and C_{D} symbol).	

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

20/20 DocID15992 Rev 4



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Analogue Switch ICs category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

FSA3051TMX NLAS4684FCTCG NLAS5223BLMNR2G NLX2G66DMUTCG 425541DB 425528R 099044FB NLAS5123MNR2G PI5A4157CEX PI5A4599BCEX NLAS4717EPFCT1G PI5A3167CCEX SLAS3158MNR2G PI5A392AQE PI5A4157ZUEX PI5A3166TAEX FSA634UCX XS3A1T3157GMX TC4066BP(N,F) DG302BDJ-E3 PI5A100QEX HV2605FG-G HV2301FG-G RS2117YUTQK10 RS2118YUTQK10 RS2227XUTQK10 ADG452BRZ-REEL7 MAX4066ESD+ MAX391CPE+ MAX4730EXT+T MAX314CPE+ BU4066BCFV-E2 MAX313CPE+ BU4S66G2-TR NLASB3157MTR2G TS3A4751PWR NLAST4599DFT2G NLAST4599DTT1G DG300BDJ-E3 DG2503DB-T2-GE1 TC4W53FU(TE12L,F) HV2201FG-G 74HC2G66DC.125 DG3257DN-T1-GE4 ADG619BRMZ-REEL ADG1611BRUZ-REEL7 DG2535EDQ-T1-GE3 LTC201ACN#PBF 74LV4066DB,118 ISL43410IUZ